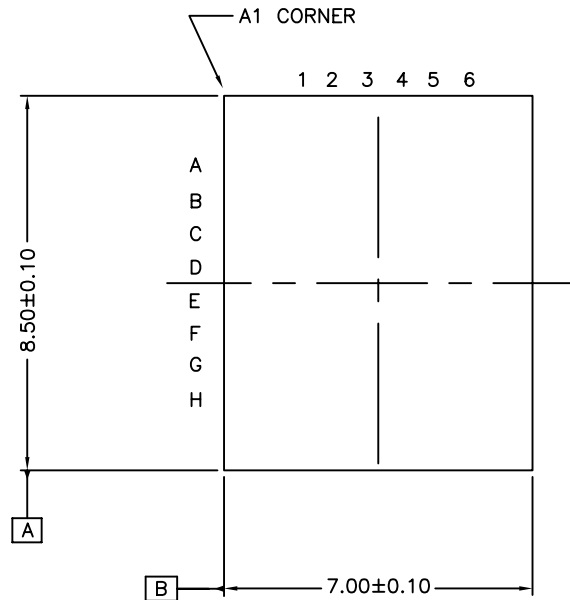
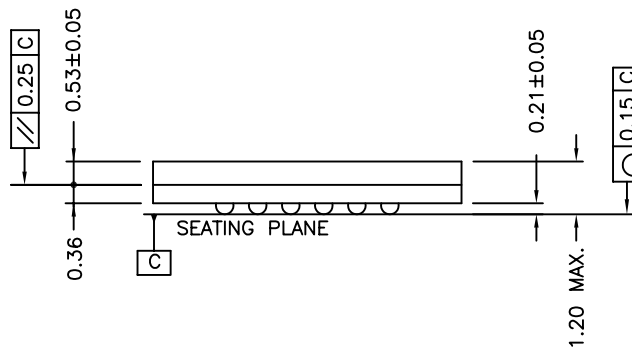
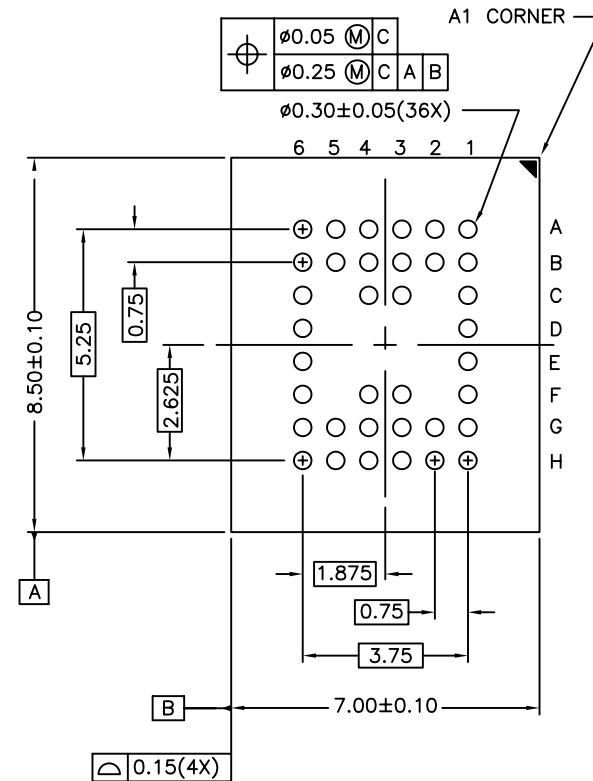


REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	-	**	60327	NEW RELEASE	01/11/99	N/A
1	-	*A	60978	CORRECT PKG. LENGTH & WIDTH TOLERANCE	02/24/99	N/A
1	-	*B	100314	CHG. TOLERANCE/ CHG. DIM. ON PKG. THICK	06/08/00	N/A
1	-	*C	107076	CHANGE TITLE	05/08/01	N/A
1	-	*D	118366	CHG. PKG. BODY TOLERANCE/ADD MOLD CAP & SUBSTRATE DIM./CHG. LEAD COPLANARITY/ CHANGE TITLE	08/28/02	N/A
1	-	*E	2820579	Changed template & Title from 36 FBGA (7.0x8.5x1.20MM) PKG. OUTL to PACKAGE OUTLINE, 36L FBGA 7.0X8.5X1.2 MM BA36B.	12/09/09	QAD
1	-	*F	3313065	NO CHANGE. SUNSET REVIEW.	07/14/11	N/A


TOP VIEW



BOTTOM VIEW



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	DRAWN BY HTN	DATE 08/28/02		
	CHECKED BY QAD	DATE 07/14/11		
	APPROVED BY ECVI	DATE 07/14/11		
MATERIAL N/A	APPROVED BY BTL	DATE 07/14/11	TITLE PACKAGE OUTLINE, 36L FBGA 7.0X8.5X1.2 MM BA36B	
FINISH N/A	APPROVED BY N/A	DATE N/A	SIZE A	PART NO. BA36B DWG NO. 51-85105 REV *F
		SCALED TO FIT N/A	SHEET 1 OF 1	